### Overview



### HP Pro Tower 290 G9 Desktop PC

- 1. Slim-height Bay supporting an optical disk drive (Optional)
- 2. Power Button
- 3. Combo jack, Headphone/ Microphone
- 4. (4) SuperSpeed USB 5Gbps signaling rate port<sup>1</sup>

#### <u>Not shown</u>

Slots

(1) PCI Express 4.0 x16<sup>2</sup> (1) PCI Express 3.0 x1 (1) M.2 for WLAN (1) M.2 2242/2280 storage Bays

(2) 3.5" (1) 9.5mm internal optical drive bay

1. SuperSpeed USB 10Gbps = USB 3.2 Gen2. SuperSpeed USB 5Gbps = USB 3.2 Gen1.

2. Support discrete graphic cards and storage devices only.



## Overview



- 1. Audio Line out
- 2. Audio Line in
- 3. Standard lock slot
- 4. VGA Port
- 5. HDMI Port

### <u>Not shown</u>

(1) Parallel Port (Optional via PCIex1 slot)

- (1) 4 Serial Port (Optional via PCIex1 slot)<sup>2</sup>
- (1) Intrusion Sensor (Optional)

- 6. Connector (4) USB 2.0 port
- 7. RJ-45 Network
- 8. Serial port (optional)
- 9. Integrated accessories cable lock
- 10. Power Cord Connector<sup>1</sup>
- 11. Padlock Loop

1. Power cord connector will be in different position, depends on which power supply configured.

3. Available in select countries only.



Overview

### AT A GLANCE

- Windows 11 Pro 64, Win 11 Home 64 or FreeDOS.
- Intel<sup>®</sup> H670 chipset supporting Intel<sup>®</sup> 13<sup>th</sup> or 14<sup>th</sup> processors<sup>1</sup> featuring Intel<sup>®</sup> UHD Graphics.
- Supports an optional discrete graphics card.
- Integrated 10/100/1000 Ethernet Controller or Realtek RTL8821CE-CG 802.11 a/b/g/n/ac (1x1) Wi-Fi5 and Bluetooth<sup>®</sup> 4.2 Wireless Card or Realtek RTL8822CE-CG 802.11 a/b/g/n/ac (2x2) Wi-Fi5 and Bluetooth<sup>®</sup> 5.0 Wireless Card or Realtek RTL8852BE 802.11 a/b/g/n/ac(ax (2x2) Wi-Fi6 and Bluetooth<sup>®</sup> 5.3 Wireless Card
- Up to 64GB DDR4-3200 Unbuffered Memory (UDIMM).
- Independent monitor support via VGA and HDMI interfaces.
- TPM2.0 support (Non-PCI version supports fTPM)<sup>1</sup>.
- Supports both Hard Disk Drives and PCIe<sup>®</sup> NVMe<sup>™</sup> M.2 SSD or PCIe<sup>®</sup> NVMe<sup>™</sup> TLC M.2 SSD.
- Up to 8 USB Ports.
- 180W/350W/500W 90% HE power supply and 260W 92% HE power supply.
- Security cable lock supported (sold separately).
- Intrusion sensor supported (Optional).
- Optional HP Services available<sup>2</sup>; terms and conditions vary by country; certain restrictions and exclusions apply.

1. Available on select skus only.

2. HP Services are optional. Service levels and response times for HP Care Services may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <a href="http://www.hp.com/go/cpc">http://www.hp.com/go/cpc</a>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

#### NOTE: See important legal disclosures for all listed specs in their respective features sections.

### **PRODUCT NAME**

HP Pro Tower 290 G9 Desktop PC

### **OPERATING SYSTEM**

Preinstalled

Windows 11 Pro<sup>1</sup> Windows 11 Home - HP recommends Windows 11 Pro for Business<sup>1</sup> Windows 11 Home Single Language - HP recommends Windows 11 Pro for Business<sup>1</sup> FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>.

Standard Features and Configurable Modules

### PROCESSORS

#### 12th Gen Non-PCI

13th /14th Gen Non-PCI

12 <sup>th</sup> Gen Processor	Х	
13 <sup>th</sup> Gen Processor		Х
14 <sup>th</sup> Gen Processor		Х

#### Intel<sup>®</sup> Celeron<sup>®</sup> Processors<sup>1,2</sup>

Intel<sup>®</sup> Core<sup>™</sup> 300 with Intel UHD Graphics 710 (3.9 GHz P-core base frequency, 6 MB L3 cache, 2 P-cores, 4 threads)

### Intel 13<sup>th</sup> Processors

Intel® Core™ i3¹

CPU Intel Core i3-13100 4C 3.4GHz 3200MHz 60W (3.4GHz, turbo up to 4.5GHz, 12MB cache, 4 cores)

#### Intel® Core™ i5<sup>1</sup>

CPU Intel Core i5-13400 10C 2.5GHz 3200MHz 65W (2.5GHz, turbo up to 4.6GHz, 20MB cache, 10 cores) CPU Intel Core i5-13500 14C 2.5GHz 3200MHz 65W (2.5GHz, turbo up to 4.8GHz, 24MB cache, 14 cores)

#### Intel® Core™ i7¹

CPU Intel Core i7-13700 16C 2.1GHz 3200MHz 65W (2.1GHz, Up to 5.2GHz with Intel® Turbo Boost<sup>2</sup>, 30MB cache, 16 cores)

#### Intel 14<sup>th</sup> Processors

#### Intel<sup>®</sup> Core™ i3<sup>1</sup>

Intel<sup>®</sup> Core<sup>™</sup> i3-14100 with Intel UHD Graphics 730 (3.5 GHz P-core base frequency, up to 4.7 GHz P-core Max Turbo frequency, 12 MB L3 cache, 4 P-cores, 8 threads).

#### Intel<sup>®</sup> Core™ i5<sup>1</sup>

Intel<sup>®</sup> Core<sup>™</sup> i5-14600 with Intel UHD Graphics 770 (2.0 GHz E-core base frequency, 2.7 GHz P-core base frequency, up to 3.9 GHz E-core Max Turbo frequency, up to 5.2 GHz P-core Max Turbo frequency, 24 MB L3 cache, 6 P-cores and 8 E-cores, 20 threads), supports Intel<sup>®</sup> vPro<sup>®</sup> Technology.

Intel<sup>®</sup> Core<sup>™</sup> i5-14500 with Intel UHD Graphics 770 (1.9 GHz E-core base frequency, 2.6 GHz P-core base frequency, up to 3.7 GHz E-core Max Turbo frequency, up to 5.0 GHz P-core Max Turbo frequency, 24 MB L3 cache, 6 P-cores and 8 E-cores, 20 threads), supports Intel<sup>®</sup> vPro<sup>®</sup> Technology.

Intel<sup>®</sup> Core<sup>™</sup> i5-14400 with Intel UHD Graphics 730 (1.8 GHz E-core base frequency, 2.5 GHz P-core base frequency, up to 3.5 GHz E-core Max Turbo frequency, up to 4.7 GHz P-core Max Turbo frequency, 20 MB L3 cache, 6 P-cores and 4 E-cores, 16 threads).

### Intel® Core™ i7<sup>1</sup>

Intel<sup>®</sup> Core<sup>™</sup> i7-14700 with Intel UHD Graphics 770 (1.5 GHz E-core base frequency, 2.1 GHz P-core base frequency, up to 4.2 GHz E-core Max Turbo frequency, up to 5.3 GHz P-core Max Turbo frequency, 33 MB L3 cache, 8 P-cores and 12 E-cores, 28 threads), supports Intel<sup>®</sup> vPro<sup>®</sup> Technology.

 Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing system required. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
 Intel® Turbo Boost technology requires a PC with a processor with Intel Turbo Boost capability. Intel Turbo Boost performance varies depending on hardware, software and overall system. See http://www.intel.com/technology/turboboost for more information.



## Standard Features and Configurable Modules

### CHIPSET

Intel® H670 Chipset

### GRAPHICS

Graphic Card	12th Gen Non-PCI	13th /14th Gen Non-PCI
Intel Arc A380 6GB GDDR6 GFX		Х
NVIDIA GeForce RTX 4060 8GB GDDR6 GFX		X
AMD Radeon RX 6300 2GB GDDR6 GFX	Х	X
NVIDIA GeForce RTX 3050 8GB GDDR6 GFX		
AMD Radeon RX 6400 4GB GDDR6 GFX	Х	
AMD Radeon RX 6600XT 8GB GDDR6 GFX	Х	

#### Integrated<sup>1,2</sup>

Intel<sup>®</sup> UHD Graphics 770 Graphics 730 Graphics 710

#### **Discrete Graphics**

AMD Radeon™ RX 6300 Graphics (2 GB GDDR6) Intel Arc A380 Graphics (6GB GDDR6) NVIDIA® GeForce RTX 4060 Graphics (8 GB GDDR6)

1. HD content required to view HD images.

2. Integrated Intel software is available on select models only and requires separately purchased projector, tv or computer monitor with an integrated or external receiver. External receivers connect to the projector, tv or computer monitor via a standard VGA, HDMI cable, also sold separately.

**\*NOTE:** Available in select countries only.



Standard Features and Configurable Modules

### MEMORY

Memory	12th Gen Non-PCI	13th /14th Gen Non-PCI
DDR4 3200	X	Х
DDR5 4800		
DDR5 5600		

Form Factor	Туре	Maximum	# of Slots
Tower	DDR4 3200	64 GB capacity	2 DIMM <sup>1</sup>
4GB DDR4-3200 UDIM	M NECC (1x4GB)		
8GB DDR4-3200 UDIM	M NECC (1x8GB)		
8GB DDR4-3200 UDIMM NECC (2x4GB) <sup>2</sup>			
16GB DDR4-3200 UDIMM NECC (1x16GB)			
16GB DDR4-3200 UDII	MM NECC (2x8GB) <sup>2</sup>		
32GB DDR4-3200 UDII	MM NECC (1x32GB)		
32GB DDR4-3200 UDIMM NECC (2x16GB) <sup>2</sup>			
64GB DDR4-3200 UDII	MM NECC (2x32GB) <sup>2</sup>		

1. Memory modules support data transfer rates up to 2933 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

2. Memory speed 3200 MT/s can be achieved via two UDIMMs per channel (2DPC) when populated with the same part number.

**NOTE:** DDR4-2933 UDIMM is only available for 10<sup>th</sup> Gen i7 processor.

Standard Features and Configurable Modules

### STORAGE

**NOTE:** Starting from November 1<sup>st</sup>, 2023, all shipments will require Windows to be installed when selecting a SSD. HDD can only be configured as additional data drives and not as the boot drive.

#### SATA3 - 3.5" or 2.5" 6Gb/s HDDs

2TB 7200 RPM SATA Hard Disk Drive

1TB 7200 RPM SATA Hard Disk Drive

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software.

#### **Solid State Drives**

256GB\* M.2 NVMe 512GB\* M.2 NVMe 1TB\* M.2 NVMe 128GB\* M.2 2230 PCIe NVMe\* 128GB\* M.2 2280 PCIe NVMe Three Layer Cell SSD 256GB\* M.2 2280 PCIe NVMe Three Layer Cell SSD 512GB\* M.2 2280 PCIe NVMe Three Layer Cell SSD 1TB\* M.2 2280 PCIe NVMe Three Layer Cell SSD

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) of system disk is reserved for the system recovery software. **\*NOTE:** Available in select countries only.

### **OPTICAL DISC DRIVES**

DVD-ROM 9.5mm DVD-Writer<sup>1</sup> 9.5mm

1. HD-DVD disks cannot be played on this drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs. Discs burned with this drive may not be compatible with many existing singlelayer DVD drives and players.



Standard Features and Configurable Modules

### **NETWORKING<sup>1</sup>**

Ethernet (RJ-45) Integrated 10/100/1000M GbE LAN

#### Wi-Fi® and Bluetooth®

Realtek RTL8852BE 802.11 a/b/g/n/ac/ax (2x2) Wi-Fi6 and Bluetooth<sup>®</sup> 5.3 Wireless Card Realtek RTL8822CE-CG 802.11 a/b/g/n/ac (2x2) Wi-Fi5 and Bluetooth<sup>®</sup> 5.0 Wireless Card Realtek RTL8821CE-CG 802.11 a/b/g/n/ac (1x1) Wi-Fi5 and Bluetooth<sup>®</sup> 4.2 Wireless Card

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.

**NOTE:** Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited.

### AUDIO / MULTIMEDIA

Realtek ALC3867-CG Integrated Hi-Definition Audio Combo Jack, Headphone / Microphone Line-in / Line-out (3.5mm)

### **KEYBOARDS AND POINTING DEVICES<sup>1</sup>**

#### Keyboard

HP USB 320K Keyboard HP 125 BLK Wired Keyboard HP 125 Antimicrobial Wired Keyboard (china only) HP PS/2 Business Slim Keyboard (for machine configured with PS/2 port)

#### Mouse

HP PS/2 mouse (for machine configured with PS/2 port) HP Wired Desktop 320M mouse HP 125 Wired Mouse HP 128 Laser Wired Mouse HP 125 Antimicrobial Wired Mouse (china only)

1. Keyboards and mouse are optional or add-on features. A keyboard and mouse are required for this device. If you do not already have a keyboard and mouse, please refer to a list of compatible keyboards on the "Recommended Accessories" page.



Standard Features and Configurable Modules

### PORTS

Front I/O	12th Gen Non-PCI	13th /14th Gen Non-PCI
ODD (option)	Х	Х
Power Button	Х	Х
Combo jack, Headphone/ Microphone	Х	Х
SD card reader (option)		
SuperSpeed USB 5Gbps signaling rate port	(4)	(4)
SuperSpeed USB 10Gbps signaling rate port		
USB 2.0 port		
USB-C 3.2 G1 (5G)		

Intel 13<sup>th</sup>, 14<sup>th</sup> Gen Front Slim-height Bay - supporting an optical disk drive (Optional) Power Button Combo jack, Headphone / Microphone (4) SuperSpeed USB 5Gbps signaling rate port\*

#### Not shown

(1) PCI Express 4.0 x16
(1) PCI Express 3.0 x1
(1) M.2 for WLAN
(1) M.2 2230/2280 storage

#### Rear

Audio Line out Audio Line in HDMI Port VGA Port Standard Lock Slot (4) USB 2.0 port RJ-45 Network connector Power cord connector Padlock loop Integrated accessories cable lock Serial port (optional)



## Standard Features and Configurable Modules

#### Not shown

- (1) Parallel Port (Optional via PCIex1 slot)
- (1) 4x Serial port (Optional via PCIex1 slot)\*
- (1) Intrusion Sensor (Optional)

**NOTE\*:** Available in select countries only. **NOTE\*\*:** SuperSpeed USB 10Gbps = USB 3.2 Gen2. SuperSpeed USB 5Gbps = USB 3.2 Gen1

### BAYS

- (1) 9.5mm external slimline ODD bay (Optional)
- (1) 3.5" internal HDD or bay
- (1) 3.5" internal HDD bay (share bay with caddy)



Standard Features and Configurable Modules

### SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

#### Security and Protection McAfee\* LiveSafe™<sup>1</sup>

#### Productivity

Microsoft 365<sup>2</sup> Xerox<sup>®</sup> DocuShare<sup>®</sup> (90 days free trial offer)<sup>3</sup>

**ODD Playback** sMedio True DVD for HP

Movies

Netflix<sup>4</sup>

App Stores and Content Purchasing Amazon<sup>4</sup>

#### **HP Utilities and Support**

HP Documentation HP Audio Switch<sup>5</sup> HP Support Assistant myHP

BTB

HP Setup Integrated OOBE

#### Hardware Enabling Drivers or software utility

HP System Event Utility

1. Free 1-year subscription of McAfee LiveSafe service included. Internet access required and not included. Subscription required after expiration 2. Sold separately and requires Internet access for activation.

3. Simply sign up and start using Xerox<sup>®</sup> DocuShare<sup>®</sup> Go. No credit card. No obligation. Data will become unavailable unless a subscription is entered before the end of the 90 day free trial period. See visit https://http://www.xerox.com/docusharego for details.

4. Internet access required and not included.

5. Easily switch between speaker and microphone sources with intuitive controls and a consistent app experience.

**\*NOTE**: Available in Latin America countries only.

### **POWER SUPPLY<sup>1</sup>**

180 W EPA90 (Gold) +12V 260W EPA92 +12V 350 W EPA90 (Gold) Power Supply 500 W EPA90 (Gold) Full range 115V/230V

1. All power supplies are not available in every region.



Standard Features and Configurable Modules

### **DIMENSIONS AND WEIGHT**

#### Dimensions

6.12 x 11.93 x 13.28 in (155 x 303 x 337 mm)

#### Weight

10.4 lbs / 4.7 kg

### UNIT ENVIRONMENT AND OPERATING CONDITIONS

#### **General Unit Operating Guidelines**

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range	Operating: 5° to 35° C1 Non-operating: -30° to 60° C1
Relative Humidity	Operating: 5% to 90% (non-condensing at ambient) Non-operating: 5% to 90% (non-condensing at ambient)
Maximum Altitude (unpressurized)	Operating: 5000 m Non-operating: 50000ft (15240 m)

1. Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

<b>Eco-Label Certifications</b>	This product has received or is in the process of being certified to the following approvals and may be
& declarations	labeled with one or more of these marks:
	IT ECO declaration
	• US ENERGY STAR <sup>®</sup>
	• US Federal Energy Management Program (FEMP)
	• EPEAT <sup>®</sup> Gold* or EPEAT Silver** registered in the United States. See http://www.epeat.net for
	registration status in your country.
	China Energy Conservation Program (CECP)
	<ul> <li>China State Environmental Protection Administration (SEPA)</li> </ul>
	• Taiwan Green Mark
	<ul> <li>Commission Regulation (EC) No 617/2013 (ErP Lot 3)</li> </ul>
	Note*: Only available on 13th Gen CPU Legacy SKU, except Japan.
	Note**: Available on all 12th Gen CPU SKUs, 13th Gen non-legacy SKUs, and 13th Gen legacy SKUs for Japan.



## Standard Features and Configurable Modules

Sustainable Impact Specifications	<ul> <li>Product Carbon Footprint (hp.com)</li> <li>29.8% post-consumer recycled plastic</li> <li>Low halogen</li> <li>Outside Box and corrugated cushions are 100% sustainably sourced and recyclable</li> <li>Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable.</li> <li>Bulk packaging available</li> </ul>		
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Desktop model is based on a "Typically Configured Desktop".		
Energy Consumption (in accordance with US ENERGY STAR® test method)			100VAC, 50Hz
Normal Operation (Short idle)	16.34 W	17.06 W	16.41 W
Normal Operation (Long idle)	16.31 W	16.04 W	16.15 W
Sleep	1.74 W	1.73 W	1.76 W
Off	0.32 W	0.33 W	0.32 W
Heat Dissipation*	offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.115VAC, 60Hz230VAC, 50Hz100VAC, 50Hz		/indows <sup>®</sup> operating system.
Normal Operation (Short idle)	55.72 BTU/hr 58.17 BTU/hr 55.9		55.96 BTU/hr
Normal Operation (Long idle)	55.62 BTU/hr 54.70 BTU/hr 55.0		55.07 BTU/hr
Sleep	5.93 BTU/hr	5.90 BTU/hr	6.00 BTU/hr
			1.09 BTU/hr
Off			
	<b>NOTE:</b> Heat dissipation is calculated bashour.	sed on the measured watts, assumin	
Off Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	NOTE: Heat dissipation is calculated ba	sed on the measured watts, assumin	
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) Typically Configured –	NOTE: Heat dissipation is calculated bas hour. Sound Power	sed on the measured watts, assumin	g the service level is attained for one Sound Pressure
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) Typically Configured – Idle Fixed Disk – Random writes	NOTE: Heat dissipation is calculated bas hour. Sound Power (L <sub>WAd</sub> , bels)	sed on the measured watts, assumin	g the service level is attained for one Sound Pressure (L <sub>pAm</sub> , decibels)
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296) Typically Configured – Idle Fixed Disk – Random	NOTE: Heat dissipation is calculated bas hour. Sound Power (L <sub>WAd</sub> , bels) 3.6		g the service level is attained for one Sound Pressure (L <sub>pAm</sub> , decibels) 25 26 26

## Standard Features and Configurable Modules

Batteries	This battery	s) in this product comply with EU Directive 2006/66/EC	
	Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight		
	Battery size: Battery type	CR2032 (coin cell) : Lithium	
Additional Information		ct is in compliance with the Restrictions of Hazardous Subs	stances (RoHS) directive -
	2011/65/EC.		
		oduct is designed to comply with the Waste Electrical and E	lectronic Equipment (WEEE)
	Directive – 2	002/96/EC. ct is in compliance with California Proposition 65 (State of I	California: Cafe Drinking Water
		forcement Act of 1986).	California, Sale Drinking water
		ct is in compliance with the IEEE 1680.1 (EPEAT) standard a	at the Gold level, see
	http://www.		
		rts weighing over 25 grams used in the product are marked	d per IS011469 and IS01043.
		ct contains 28.2% post-consumer recycled plastic (by wt.)	
		ct is 92.9% recycle-able when properly disposed of at end	
Packaging Materials	External:	PAPER/Paperboard	1220 g
	Internal:	PAPER/Molded Pulp	580 g
		PLASTIC/Polyethylene low density - LDPE	40 g
		ackaging material contains at least 0.0% recycled content	
		ted paper packaging materials contains at least 35.0% rec	
	<ul> <li>HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to oproducts worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.</li> <li>We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.</li> <li>We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evol</li> <li>To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.</li> </ul>		ances (RoHS) Directive to our
			of additional substances—
			ill continue to extend the
			position statement.
Material Usage       This product does not contain any of the following substances in excess of regulatory limits the HP General Specification for the Environment at <a href="http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf">http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf</a> ):         • Asbestos       • Certain Azo Colorants         • Certain Brominated Flame Retardants – may not be used as flame retardants in plastics         • Cadmium			
		lf):	
		ardants in plastics	
		מימטונס ווי פומסנונס	
	Calification     Calification     Chlorinated Hydrocarbons     Chlorinated Paraffins     Formaldehyde		
Halogenated Diphenyl Methanes			
	Lead carbonates and sulfates		
Lead and Lead compounds			
	Mercuric O	kide Batteries	



## Standard Features and Configurable Modules

	• Nickel – finishes must not be used on the external surface designed to be frequently handled or
	carried by the user.
	Ozone Depleting Substances
	Polybrominated Biphenyls (PBBs)
	Polybrominated Biphenyl Ethers (PBBEs)
	Polybrominated Biphenyl Oxides (PBBOs)
	Polychlorinated Biphenyl (PCB)
	Polychlorinated Terphenyls (PCT)
	• Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been
	voluntarily removed from most applications.
	Radioactive Substances
	• Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
	• Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging
	materials.
	• Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
	Design packaging materials for ease of disassembly.
	• Maximize the use of post-consumer recycled content materials in packaging materials.
	• Use readily recyclable packaging materials such as paper and corrugated materials.
	<ul> <li>Reduce size and weight of packages to improve transportation fuel efficiency.</li> </ul>
	• Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life	HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To
Management and	recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP
Recycling	sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible
	manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for
	each product type for use by treatment facilities. This information (product disassembly instructions)
	is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions
	may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who
	integrate and re-sell HP equipment.
	Global Citizenship Report
	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates:
	http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842
	and
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
4	



## Standard Features and Configurable Modules

### SERVICE AND SUPPORT

On-site Warranty<sup>1</sup>: Available three-year (3-3-3) or one-year (1-1-1) limited warranty (varies by country) delivers on-site, next business day<sup>2</sup> service for parts and labor and complimentary limited technical support<sup>3</sup>. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Pack<sup>4</sup> To choose the right level of service for your HP product, visit HP Care Pack Central: http://www.hp.com/go/cpc.

1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region. 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. 3: Technical support applies only to HP-configured and third-party HP qualified hardware and software.

4: Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications - Graphics

### GRAPHICS

Intel <sup>®</sup> UHD Graphics (integrate	ed)
Graphics Controller	Integrated
DisplayPort™	Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream Technology for a maximum of 4 displays connected to any output controlled by Intel® Graphics
HDMI	Supports HDMI 2.0a features Supports HDCP 2.2 Supports audio over HDMI
VGA	VGA output
Memory	The actual amount of maximum graphics memory can be >4GB. System memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.
Maximum Color Depth	up to 10 bits/color
Graphics/Video API Support	HEVC 10b Enc/Dec HW VP9 10b Dec HW HDR Rec. 2020 DX12
Supported Display Resolutions and Refresh Rates	Max. Resolution (VGA) 2048 x 1536 @60Hz Max. Resolution (HDMI) 7680 x 4320 @60Hz

**Note:** The actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

**Note:** other resolutions may be available but are not recommended as they may not have been tested and qualified by HP Only supported on displays connected to the external DisplayPort<sup>™</sup> connector.

#### AMD Radeon™ RX 6300 4GB Graphics Card

Engine Clock	1512MHz (Game) 2040MHz (Boost)
Memory Clock	2000 MHz
Memory Size(width)	2GB (64-bit)
Memory Type	512M x 32 GDDR6
Max. Resolution (HDMI)	7680 x 4320x 36bpp@60Hz
Max. Resolution (DP)	7680 x 4320 x 24bpp@120Hz
Multi Display Support	2 displays
HDCP Compliance	Yes
Rear I/O connectors (bracket)	HDMI+DP
Cooling (active/passive)	Active fan-sink (Active cooling with dynamic speed)
Total power consumption (W)	32W
PCB form-factor with bracket	LP PCB with FH/LP bracket



Technical Specifications - Graphics

### NVIDIA® GeForce RTX 4060 8GB Graphics Card

Engine Clock	1830Mhz
Memory Clock	17Gbps
Memory Size (width)	8GB (128-bit)
Memory Type	512M x 32 GDDR6
Max. Resolution (DP)	7680 x 4320@60Hz
Multi Display Support	7680 x 4320@60Hz
HDCP Compliance	Up to 4 displays
Rear I/O connectors (bracket)	Yes
Cooling (active/passive)	DPx3+ HDMIx1
Total power consumption (W)	Active fansink
PCB form-factor with bracket	115W

### Intel<sup>®</sup> Acr A380 6GB Graphics Card

Graphic Clock	2000Mhz
Memory Clock	1937.5Mhz
Memory Size (width)	6GB (96-bit)
Memory Type	512M x 32 GDDR6
Max. Resolution (DP)	DP 1.3/1.4a ready / 5K@120Hz/8K@60Hz HDR 12b
Max. Resolution (HDMI)	HDMI 2.0b /4K@60HZ
HDCP Compliance	Up to 4 displays
Rear I/O connectors (bracket)	Yes
Cooling (active/passive)	DPx3+ HDMIx1
Total power consumption (W)	Active fansink with 4 pin fan control
PCB form-factor with bracket	75W



Technical Specifications – Optical Drives

### STORAGE\*

**NOTE:** Starting from November 1<sup>st</sup>, 2023, all shipments will require Windows to be installed when selecting a SSD. HDD can only be configured as additional data drives and not as the boot drive.

### HP 2TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	2TB
Rotational Speed	7,200 rpm
Interface	SATA 6Gb/s NCQ
Buffer Size	64MB
Logical Blocks	3,907,029,168
Seek Time	Read: <8.5 ms Write: <9.5 ms
Height	1.028 in/26.11 mm
Width	4.0 in/101.6 mm
Operating Temperature	32° to 140° F (0° to 60° C)

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

### 1TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	1TB
Rotational Speed	7,200 rpm
Interface	Serial ATA 3.0 (6.0 Gb/s)
Buffer Size	32MB
Logical Blocks	1,953,525,168
Seek Time	Single Track: 2.0 ms Average: 11 ms Full-Stroke: 21 ms
Height	1 in/2.54 cm
Width	Media diameter: 3.5 in/8.89 cm Physical size: 4 in/10.2 cm
Operating Temperature	41° to 131° F (5° to 55° C)

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.



Technical Specifications – Optical Drives

### 128GB M.2 2280 PCIe NVMe Three Layer Cell SSD

Drive Weight	< 10g
Capacity	128GB
Height	2.38mm
Length	80mm
Width	22mm
Interface	PCIE Gen4x4
Maximum Sequential Read	Up to 2800MB/s
Maximum Sequential Write	Up to 600MB/s
Logical Blocks	250,069,680
Operating Temperature	0° to 70°C (32° to 158°F) [ambient temp]
Features	APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

### 256GB M.2 2280 PCIe NVMe Three Layer Cell SSD

Drive Weight	< 10g
Capacity	256GB
Height	2.38mm
Length	80mm
Width	22mm
Interface	PCIE Gen4x4
Maximum Sequential Read	Up to 2700MB/s
Maximum Sequential Write	Up to 1000MB/s
Logical Blocks	500,118,192
Operating Temperature	0° to 70°C (32° to 158°F) [ambient temp]
Features	APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 512GB M.2 2280 PCIe NVMe Three Layer Cell SSD

Drive Weight	< 10g
Capacity	512GB
Height	2.38mm
Length	80mm
Width	22mm
Interface	PCIE Gen4x4
Maximum Sequential Read	Up to 2900MB/s
Maximum Sequential Write	Up to 1100MB/s



## Technical Specifications – Optical Drives

Logical Blocks	1,000,215,216
Operating Temperature	0° to 70°C (32° to 158°F) [ambient temp]
Features	APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

#### 256GB M.2 2280 PCIe NVMe SSD

Drive Weight	< 10g
Capacity	256GB
Height	2.38mm
Length	80mm
Width	22mm
Interface	PCIE Gen4x4
Maximum Sequential Read	Up to 1600MB/s
Maximum Sequential Write	Up to 780MB/s
Logical Blocks	500,118,192
Operating Temperature	0° to 70°C (32° to 158°F) [ambient temp]
Features	APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.

### 512GB M.2 2280 PCIe NVMe SSD

Drive Weight	< 10g
Capacity	512GB
Height	2.38mm
Length	80mm
Width	22mm
Interface	PCIE Gen4x4
Maximum Sequential Read	Up to 1600MB/s
Maximum Sequential Write	Up to 860MB/s
Logical Blocks	1,000,215,216
Operating Temperature	0° to 70°C (32° to 158°F) [ambient temp]
Features	APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.



Technical Specifications – Optical Drives

#### 128GB M.2 2230 PCIe NVMe SSD

Drive Weight	< 10g
Capacity	128GB
Height	2.3mm
Length	30mm
Width	22mm
Interface	PCIE NVMe
Maximum Sequential Read	Up to 1600MB/s
Maximum Sequential Write	Up to 780MB/s
Logical Blocks	290,069,680
Operating Temperature	0° to 70°C (32° to 158°F) [ambient temp]
Features	Pyrite

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows) is reserved for system recovery software.



Technical Specifications – Optical Drives

### **OPTICAL DISC DRIVES**

#### HP 9.5mm Desktop G2 Slim DVD Writer Drive

Height	9.5 mm height		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB standard		
Dimensions (W x H x D)	5.04 x 0.37 x 5.0 in (128 x 9.5 x 127 mm) without bezel		
Weight (max)	0.31 lb (140 q)		
Read Speeds	DVD-R DL DVD+R DVD+RW DVD+R DL DVD-R DVD-RW CD-R CD-RW DVD-RW, DVD+RW DVD-RW, DVD+R DL DVD-R DL, DVD+R DL DVD+R, DVD-R DVD-ROM DL, DVD-ROM CD-ROM, CD-R CD-RW	Up to 6X Up to 8X Up to 8X Up to 6X Up to 6X Up to 6X Up to 24X Up to 10X Up to 8X Up to 8X Up to 8X Up to 8X Up to 8X Up to 8X Up to 24X Up to 24X	
Access time (typical reads, including settling)	Random DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical) Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical) Stop Time 6 seconds (typical)		
Power	Source Slimline SATA DC power receptacle DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)		
Environmental conditions (operating - non-condensing)	Temperature 41° to 122° F (5° to 50° C) Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)		



Technical Specifications – Optical Drives

### HP 9.5mm Desktop G2 Slim DVD-ROM Drive

Height	9.5 mm height	
Orientation	Either horizontal or vertica	l
Interface type	SATA/ATAPI	
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB s	tandard
Dimensions (W x H x D)	•	9.5 x 127 mm) without bezel
Weight (max)	0.31 lb (140 q)	
	<b>_</b>	
Read Speeds	DVD-R DL	Up to 6X
	DVD+R	Up to 8X
	DVD+RW	Up to 8X
	DVD+R DL	Up to 6X
	DVD-R	Up to 8X
	DVD-RW	Up to 6X
	CD-R	Up to 24X
	CD-RW	Up to 10X
	DVD-RW, DVD+RW	Up to 8X
	DVD-R DL, DVD+R DL	Up to 8X
	DVD+R, DVD-R	Up to 8X
	DVD-ROM DL, DVD-ROM	Up to 8X
	CD-ROM, CD-R	Up to 24X
	CD-RW	Up to 24X
Access time (typical reads, including settling)	Random DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical) Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical) Stop Time 6 seconds (typical)	
Power	Source Slimline SATA DC power receptacle DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)	
Environmental conditions (operating - non-condensing)	Temperature 41° to 122° F (5° to 50° C) Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)	



## Technical Specifications – Networking

### NETWORKING

10/100/1000 NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)
		100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30)
		1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)
		Auto-Negotiation (Automatic Speed Selection)
		Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
	Power	ACPI compliant – multiple power modes
	Management	Situation-sensitive features reduce power consumption
		Advanced link down power saving for reducing link down power consumption
	Performance	TCP/IP/UDP Checksum Offload (configurable)
	Features	Protocol Offload (ARP & NS)
		Large send offload and Giant send offload
		Receiving Side Scaling
		Jumbo Frame 9K
	Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up
		Frame); Wake-on-LAN from off (Magic Packet only)
		PXE 2.1 Remote Boot
		Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause
		30)
	Comprehensive diagnostic and configuration software suite	
		Virtual Cable Doctor for Ethernet cable status
	Interface	PCIe + SMBus
	NIC Device Driver Name	PCIe GBE Ethernet Family Controller

Realtek RTL8821CE-CG 80	2.11 a/b/g/n/ac (1x	1) Wi-Fi5 and Bluetooth® 4.2 Wireless Card
Wireless LAN Standards <sup>1</sup>	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.	
Interoperability	Wi-Fi® certified modules	
Frequency Bands	802.11b/g/n	2.402 – 2.482 GHz
		<b>NOTE:</b> The FCC has declared products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 & 15.249 or otherwise disable those channels.
	802.11a/n	4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz



Data Rates	802.11b: 1, 2, 5.5, 11 Mbps
	802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
	802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security <sup>2</sup>	IEEE and 64 / 128 bit WEP encryption for a/b/g mode only
	AES-CCMP: 128 bit in hardware
	802.1x authentication
	WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
	WPA2 certification
	IEEE 802.11i
	Cisco Certified Extensions, all versions through CCX4 and CCX Lite
	WAPI
	2 Check latest software/driver release for updates on supported security features.
Network Architecture	Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power <sup>3</sup>	802.11b: +14dBm minimum
	802.11g: +12dBm minimum
	802.11a: +12dBm minimum
	802.11n HT20(2.4GHz): +12dBm minimum
	802.11n HT40(2.4GHz): +12dBm minimum
	802.11n HT20(5GHz): +10dBm minimum
	802.11n HT40(5GHz): +10dBm minimum
	802.11ac VHT80(5GHz): +10dBm minimum
	3. Maximum output power may vary by country according to local regulations.
Power Consumption	•Transmit mode2.0 W
	•Receive mode1.6 W
	•Idle mode (PSP)180 mW(WLAN Associated)
	•Idle mode50 mW(WLAN unassociated)
	•Connected Standby 10mW
	•Radio disabled8 mW
Power Management	ACPI and PCI Express compliant power management
	802.11 compliant power saving mode



Receiver Sensitivity <sup>4</sup>	802.11b, 1Mbps: -93.5dBm maximum			
	802.11b, 11Mbps: -84dBm maximum			
	802.11a/g, 6Mbps: -86dBm maximum	802.11a/g, 6Mbps: -86dBm maximum		
	802.11a/g, 54Mbps: -72dBm maximum			
	802.11n, MCS07: -67dBm maximum			
	802.11n, MCS15: -64dBm maximum			
	802.11ac, MCS0: -84dBm maximum			
	802.11ac, MCS9: -59dBm maximum			
	4 Receiver sensitivity is measured at a packe error rate of 10% for 802.11a/g (OFDM modu	t error rate of 8% for 802.11b (CKK modulation) and a packet Ilation).		
Antenna type	Two embedded dual band 2.4/5 GHz ante	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth <sup>a</sup> communications		
Form Factors	PCI-Express M.2 MiniCard	PCI-Express M.2 MiniCard		
Dimensions	Type 2230: 2.3 x 22.0 x 30.0 mm			
Weight	Туре 2230: 2.8g			
Operating Voltage	3.3v +/- 9%			
Temperature	Operating: Non-operating:	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)		
Humidity	Operating: Non-operating:	10% to 90% (non-condensing) 5% to 95% (non-condensing)		
Altitude	Operating: Non-operating:	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)		
LED Activity	LED Amber – Radio OFF; LED White – Rad	io ON		
HP Integrated Module with Blue	tooth® 4.0/4.1/4.2 Wireless Card Technol	ogy		
Bluetooth <sup>a</sup> Specification	4.0/4.1/4.2 Wireless Card Compliant			
Frequency Band	2402 to 2480 MHz	2402 to 2480 MHz		
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)			
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up	to 2.17 Mbps		
	BLE: 1 Mbps data rate; throughput up to Legacy: Synchronous Connection Oriente			
	Legacy: Asynchronous Connection Less li 864 kbps symmetric (3-EV5)	nks 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or		



Transmit Power	The Bluetooth <sup>®</sup> component shall operate as a Class II Bluetooth <sup>®</sup> device with a maximum transmit power of + 4 dBm for BR and EDR.
Receiver Sensitivity Legacy	
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW
Range	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Electrical Interface	USB 2.0 compliant
Bluetooth° Software Supported Link Topology	Microsoft Windows Bluetooth® Software
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Certifications Bluetooth <sup>a</sup> Profiles Supported	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	Microsoft Windows ACPI, and USB Bus Support
Certifications Bluetooth <sup>®</sup> Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)



Realtek RTL8822CE-CG 802.11 a/b/g/n/ac (2x2) Wi-Fi 5 and Bluetooth® 5.0 Wireless Card	
Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
Interoperability	Wi-Fi <sup>®</sup> certified
Frequency Band	802.11b/g/n • 2.402 – 2.482 GHz 802.11a/n/ac • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz
Data Rates	<ul> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz &amp; 80MHz)</li> </ul>
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security <sup>1</sup>	<ul> <li>IEEE and Wi-Fi<sup>®</sup> compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>WAPI</li> <li>1 Check latest software/driver release for updates on supported security features.</li> </ul>
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points



	LED OFF – Radio ON
LED Activity	Non-operating:       0 to 50,000 ft (15,240 m)         LED Amber – Radio OFF;
Altitude	<b>Operating:</b> 0 to 10,000 ft (3,048 m)
Humidity	<b>Operating:</b> 10% to 90% (non-condensing) <b>Non-operating:</b> 5% to 95% (non-condensing)
-	Non-operating: –40° to 176° F (–40° to 80° C)
Temperature	<b>Operating:</b> 14° to 158° F (–10° to 70° C)
Operating Voltage	3.3v +/- 9%
Weight	1. Type 2230: 2.8g 2. Type 126: 1.3g
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm
Form Factor	PCI-Express M.2 MiniCard with CNVi Interface
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
	3 Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
	802.11ac, MCS0: -840Bin maximum 802.11ac, MCS9: -59dBm maximum
	802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum
	802.11n, MCS07: -67dBm maximum
	802.11a/g, 54Mbps: -72dBm maximum
	802.11a/g, 6Mbps: -86dBm maximum
RECEIVED SENSITIVITY	802.11b, 11Mbps: -93.50Bm maximum 802.11b, 11Mbps: -84dBm maximum
Receiver Sensitivity <sup>3</sup>	802.11 compliant power saving mode 802.11b, 1Mbps: -93.5dBm maximum
Power Management	ACPI and PCI Express compliant power management
	• Radio disabled: 8 mW
	Connected Standby/Modern Standby: 10mW
	<ul> <li>Idle mode (PSP) 180 mW (WLAN Associated)</li> <li>Idle mode:50 mW (WLAN unassociated)</li> </ul>
	Receive mode:1.6 W
Power Consumption	Transmit mode:2.0 W
	2. Maximum output power may vary by country according to local regulations.
	• 802.11ac VHT160(5GHz): +11.5dBm minimum
	• 802.11ac VHT80(5GHz): +11.5dBm minimum
	• 802.11n HT20(5GHz): +15.5dBm minimum • 802.11n HT40(5GHz): +14.5dBm minimum
	• 802.11n HT40(2.4GHz): +14.5dBm minimum
	• 802.11n HT20(2.4GHz): +15.5dBm minimum
	• 802.11a: +18.5dBm minimum
	• 802.11g: +17.5dBm minimum



Bluetooth Specification	4.0/4.1/4.2/5.0 Wireless Card Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC60950-1/IEC62368-1 UL, CSA, and CE Mark
Bluetooth <sup>®</sup> Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)



Realtek RTL8852BE 802.11 a/b/g/n/ax (2x2) Wi-Fi 6 and Bluetooth® 5.3 Wireless Card		
Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v	
Interoperability	Wi-Fi certified	
Frequency Band	802.11b/g/n • 2.402 – 2.482 GHz 802.11a/n/ac • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz	
Data Rates	<ul> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: MCS 0 ~ MCS 15, (20MHz, and 40MHz)</li> <li>802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz &amp; 80MHz)</li> </ul>	
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM	
Security <sup>1</sup>	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>WAPI</li> <li>1 Check latest software (driver release for updates on supported cognity features)</li> </ul>	
Network Architecture Models	1 Check latest software/driver release for updates on supported security features.         Ad-hoc (Peer to Peer)         Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	



• 802.11b: +18.5dBm minimum
• 802.11g: +17.5dBm minimum
• 802.11a: +18.5dBm minimum
• 802.11n HT20(2.4GHz): +15.5dBm minimum
• 802.11n HT40(2.4GHz): +14.5dBm minimum
• 802.11n HT20(5GHz): +15.5dBm minimum
• 802.11n HT40(5GHz): +14.5dBm minimum
<ul> <li>802.11ac VHT80(5GHz): +11.5dBm minimum</li> <li>802.11ac VHT160(5GHz): +11.5dBm minimum</li> </ul>
2. Maximum output power may vary by country according to local regulations.
• Transmit mode:2.0 W
Receive mode: 1.6 W
Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode:50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW
• Radio disabled: 8 mW
ACPI and PCI Express compliant power management
802.11 compliant power saving mode
802.11b, 1Mbps: -93.5dBm maximum
802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum
802.11ac, MCS0: -84dBm maximum
802.11ac, MCS9: -59dBm maximum
3 Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
High efficiency antenna with spatial diversity, mounted in the display enclosure
Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
PCI-Express M.2 MiniCard with CNVi Interface
1. Type 2230: 2.3 x 22.0 x 30.0 mm
2. Type 1216: 1.67 x 12.0 x 16.0 mm
1. Type 2230: 2.8g
2. Type 126: 1.3g
3.3v +/- 9%
<b>Operating:</b> 14° to 158° F (–10° to 70° C)
<b>Non-operating:</b> –40° to 176° F (–40° to 80° C)
<b>Operating:</b> 10% to 90% (non-condensing) <b>Non-operating:</b> 5% to 95% (non-condensing)
<b>Operating:</b> 0 to 10,000 ft (3,048 m)
Non-operating: 0 to 50,000 ft (15,240 m)
LED Amber – Radio OFF;
LED OFF – Radio ON



Bluetooth Specification	4.0/4.1/4.2/5.0 Wireless Card Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)	
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.	
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW	
Bluetooth Software Supported	Microsoft Windows Bluetooth Software	
Link Topology		
Power Management	Microsoft Windows ACPI, and USB Bus Support	
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249	
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC60950-1/IEC62368-1 UL, CSA, and CE Mark	
Bluetooth® Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)	



Technical Specifications - Audio

### **HIGH-DEFINITION AUDIO**

Туре	Integrated		
HD Stereo Codec	Realtek ALC3867-CG		
Audio I/O Ports	Front side Combo jack for supporting CTIA, Rear side Line-in/ Line-out/ Mic-in jacks		
Internal Speaker Amplifier	2W class D mono amplifier for the internal speaker only. External speakers must be powered externally.		
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio streams to be sent to/from the front and rear jacks or integrated speaker.		
HD Audio Codec	Realtek ALC3601		
Sampling	Independent sampling rates for DAC's and ADC's; supports resolutions from 16 to 24-bit; 44.1K/ 48 K/96K / 192K Hz for DAC and 44.1K/ 48K/ 96K/ 192K Hz Hz for ADC		
Wavetable Syntheses	Yes		
Analog Audio	Yes		
# of Channels on Line-Out	Stereo		
Internal Speaker	Yes		
External Speaker Jack*	2W class D mono amplifier for the internal speaker only. External speakers must be powered externally.		

NOTE\*: Optional

Technical Specifications - Power

### **POWER SUPPLY**

Operating Voltage Range	90 – 264 VAC		
Rated Voltage Range	100-240V AC		
<b>Rated Line Frequency</b>	50/60 HZ		
<b>Operating Line Frequency</b>	47 – 63 Hz		
Rated Input Current	180 W: <2.3A 260 W: ≦3.1A 350 W: <4A 500 W: <6A		
Rated Input Current with Energy Efficient* Power Supply	180 W active PFC 87/90/87% efficient at 20/50/100% load (115 V) 88/92/88% efficient at 20/50/100% load (230 V); 350 W active PFC 87/90/87% efficient at 20/50/100% load (115 V) 88/92/88% efficient at 20/50/100% load (230 V) 500W active PFC 87/90/87% efficient at 20/50/100% load (115 V) 88/92/88% efficient at 20/50/100% load (230 V)		
DC Output	+12 V		
Current Leakage (NFPA 99: 2102)	Less than 500 microamps of leakage current at 120 Vac with the ground wire disconnected, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1. Less than 100 microamps of leakage current at 120 Vac with the ground wire intact with normal polarity, as required for Non-patient Electrical Appliances and Equipment used in a patient care facility or that contact patients in normal use. Per section 10.3.5.1.		
Power Supply Fan	180 W/350 W: 70*25mm (linear type) 500 W: 70x25mm (PWM type)		

Technical Specifications – Weights and Dimensions

### **WEIGHT AND DIMENSIONS**

Chassis (W x D x H)	6.12 x 11.93 x 13.28 in (155 x 303 x 337 mm) (w/ bezel)
System Volume	15.1 L
System Weight*	10.4 lb / 4.7 kg
Packaged (H × W × D)	11.3 x 15.75 x 19.65 in 287 x 400 x 499 mm
Shipping Weight	17.64lb / 8 kg
Palletization Profile	6 units per layer 7layer max 42 per pallet Footprint -85.31x39.37x47.24 in (2167 x 1000 x1200 mm)



After-Market Options (availability may vary by region)

### **AFTERMARKET OPTIONS**

Туре	Description	Part #
Memory	HP 4GB DDR4-3200 DIMM	13L78AA
	HP 8GB DDR4-3200 DIMM	13L76AA
	HP 16GB DDR4-3200 DIMM	13L74AA
	HP 32GB DDR4-3200 DIMM	13L72AA
Storage	HP PCIe NVME TLC 256GB SSD M.2 Drive	1CA51AA
Sturaye	HP PCIe NVME TLC 512GB SSD M.2 Drive	X8U75AA
	HP PCIe Gen 4 NVME TLC M.2 512GB SSD	406L8AA
	HP PCIe Gen 4 NVME TLC M.2 1TB SSD	406L7AA
	HP 500GB 7200PRM SATA 6.0Gb/s 3.5" Hard Drive HP 1TB 7200rpm SATA 6Gb/s 3.5" Hard Drive	QK554AA QK555AA
Graphics	NVIDIA T400 4GB GDDR6 3mDP	5Z7E0AA
Security	HP Business PC Security Lock V3 Kit	3XJ17AA
	HP Keyed Cable Lock 10mm kit	T1A62AA
Cables/Adapters	HP HDMI Standard Cable Kit	
	HP USB to Serial Port Adapter	J7B60AA
	HP PCIe x1 Parallel Port Card	N1M40AA
Networking	Intel Ethernet I225-T1 GbE NIC Card	406L9AA
Input	HP Wired Desktop 320K Keyboard	95R37AA
	HP Wired Desktop 320M Mouse	9VA80AA
	HP 125 Wired Keyboard	266C9AA
	HP 125 Wired Mouse	265A9AA
	HP 128 Laser Wired Mouse	265D9AA
	HP Wired Desktop 320MK Mouse and Keyboard Combo	9SR36AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 225 Antimicrobial Wired Mouse and Keyboard Combo	286K3AA
Others	HP S101 Speaker bar	5UU40AA

## Change Log

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Date of change:	Version History:	Change	Description of change:
September 13, 2024	From v1 to v2	Correction	Sustainable impact specifications recycled plastic % corrected
February 18, 2025			Back call out image footnote removed
March 13, 2025 From V3 to V4 Removal PCI information in PROCESSORS, GRAPHICS, MEMOR removed.		PCI information in PROCESSORS, GRAPHICS, MEMORY and FRONT I/O removed.	
March 18, 2025	From V4 to V5	Correction	" PCI version supports dTPM." Removed from AAG section (1) Full-height PCI (Available on selected sku) removed from PORTS
	From V5 to V6		
	From V6 to V7		
	From V7 to V8		
	From V8 to V9		
	From V9 to V10		
	From v10 to v11		
	From v11 to v12		
	From v12 to v13		
	From v13 to v14		

